

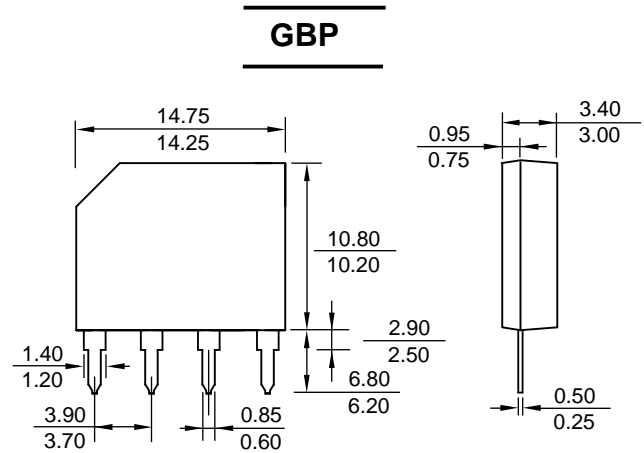
GBP2005 – GBP210

Features

- Diffused Junction
- Low Forward Voltage Drop
- High Current Capability
- High Reliability
- High Surge Current Capability
- Ideal for Printed Circuit Boards

Mechanical Data

- Case: Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: As Marked on Body
- Weight: 1.35 grams (approx.)
- Mounting Position: Any
- Marking: Type Number
- **Lead Free: For RoHS / Lead Free Version**



Dimensions in millimeters

Maximum Ratings and Electrical Characteristics @ $T_A=25^\circ\text{C}$ unless otherwise specified

Single Phase, half wave, 60Hz, resistive or inductive load.
 For capacitive load, derate current by 20%.

Characteristic	Symbol	GBP 2005	GBP 201	GBP 202	GBP 204	GBP 206	GBP 208	GBP 210	Unit
Peak Repetitive Reverse Voltage	V_{RRM}	50	100	200	400	600	800	1000	V
Working Peak Reverse Voltage	V_{RWM}								
DC Blocking Voltage	VR								
RMS Reverse Voltage	$V_{R(RMS)}$	35	70	140	280	420	560	700	V
Average Rectified Output Current (Note 1)	I_O	2.0							A
@ $T_A = 50^\circ\text{C}$									
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	60							A
Forward Voltage (per element)	VFM	1.1							V
@ $I_F = 2.0\text{A}$									
Peak Reverse Current	I_{RM}	10							μA
@ $T_A = 25^\circ\text{C}$									
At Rated DC Blocking Voltage		500							
@ $T_A = 100^\circ\text{C}$									
Typical Thermal Resistance (Note 3)	$R_{\theta JA}$	30							K/W
Operating and Storage Temperature Range	T_j, T_{STG}	-55 to +150							$^\circ\text{C}$

Note: 1. Leads maintained at ambient temperature at a distance of 9.5mm from the case.
 2. Measured at 1.0 MHz and applied reverse voltage of 4.0V D.C.
 3. Thermal resistance junction to ambient mounted on PC board with 12mm² copper pad.

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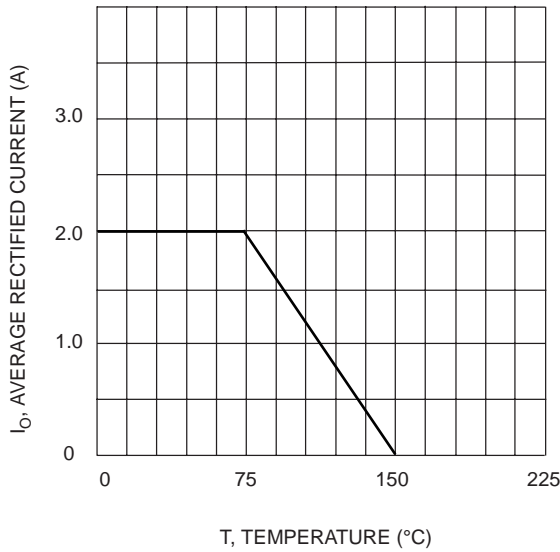


Fig. 1 Forward Current Derating Curve

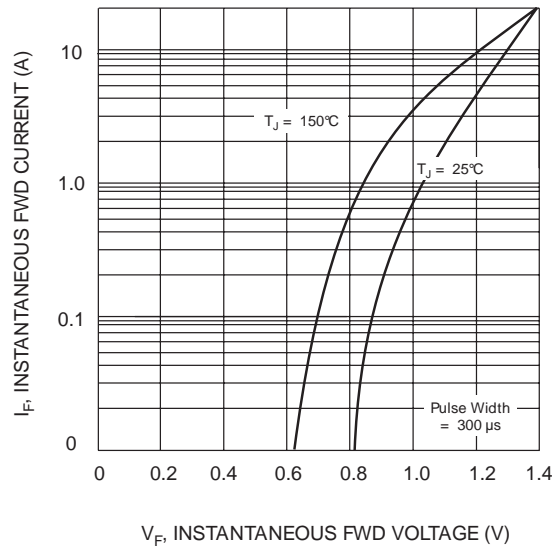


Fig. 2 Typical Fwd Characteristics

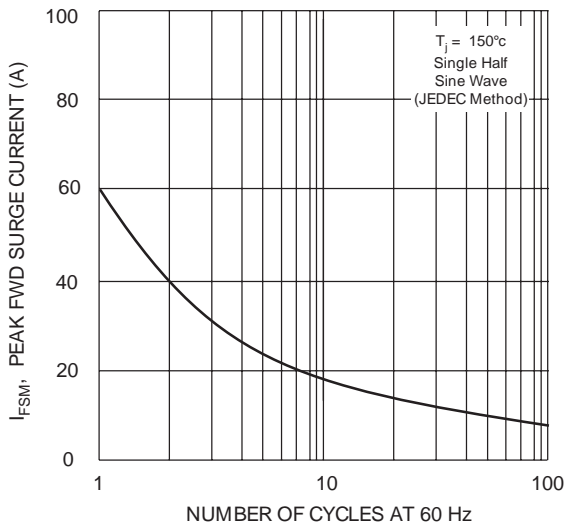


Fig. 3 Max Non-Repetitive Peak Fwd Surge Current

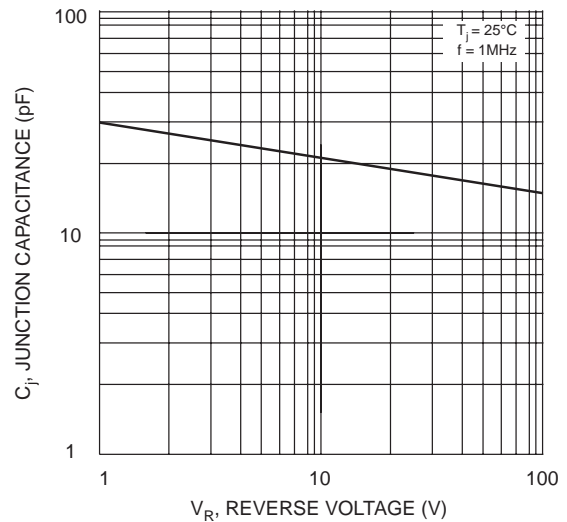


Fig. 4 Typical Junction Capacitance

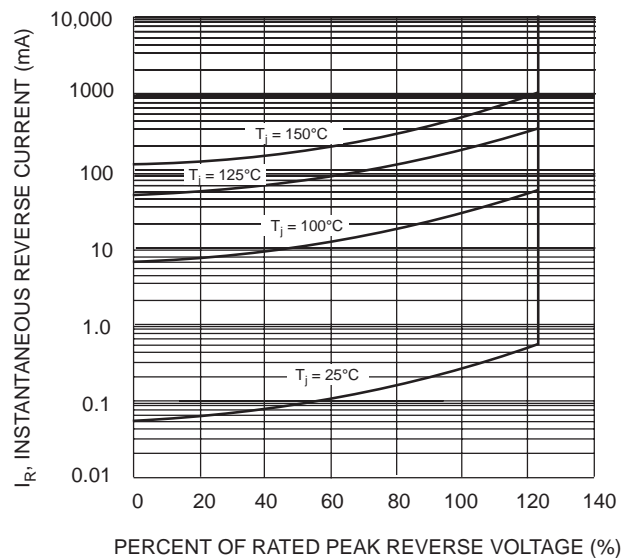


Fig. 5 Typical Reverse Characteristics